## Update on Single Event Effects in GaAs MESFETs

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## Background

#### > 1996 on Paper published by a.o. Philippe Calvel (TAS)

"Heavy ions evaluation of GaAs microwave devices"

Barillot, C.; Bensoussan, A.; Brasseau, F.; Calvel, P. Radiation Effects Data Workshop, 1996., IEEE Volume , Issue , 19 Jul 1996 Page(s):88 - 93

- Several GaAs MESFET and HFET technologies tested
- SEB achieved outside max ratings in conclusion all devices was considered good
- ESA In-flight experience of GaAs MESFET:
  - One GaAs MESFET device used in power stage of 4 SSPAs, of these SSPAs:
    - 3 failures (non-recoverable)
      - between some few days up to 6 months in operation before failure
      - All anomalies occurred in GCR intense environment.
    - 1 SSPA still operational after 5 years BUT with less severe RF level.

## Background GaAs MESFET in RF power amplifiers



### Details on test results and test setup RF Module test setup

- GaAs MESFET tested in RF matched module (flight designs)
- No added protection of gate and drain supply
- Transients and failure can be recorded
- Continously monitors performance of DUT
- RF signals tested:
  - CW at different RF level
  - Modulated RF signal (e.g. QPSK) at different RF level
- Heat dissipation handled by using copper baseplate with water cooling
  - UCL facility has been upgraded for this purpose





#### Details on test results and test setup RF Module Test Setup

GaAs MESFET tested in RF matched flight module



esa



Details on test results and test setup

#### Type of Events in RF Module test setup Examples

Single Event Transients (SET)	Enhanced SET	Destructive Failure
<20 ns pulse width	100 – 1,500 ns	





## **Results on the GaAs MESFET**

Is RF swing critical for heavy ion effects?

SOA with Argon LET(GaAs)=10.4 MeV-cm2/mg



QCA Presentation Day 2009; 27 January 2009 Page 8

## Results on the GaAs MESFET



#### Details on test results and test setup SEM picture from FA Destruction between drain and gate



Photo N°25 FIB cutting from backside (next axis) inside the transistor Fusion and diffusion of metal between Drain and Gate with craterization of GaAs

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QCA Presentation Day 2009; 27 January 2009 Page 10

# Details on test results and test setup CONCLUSION

Heavy ion irradiation test have been performed

- in Static transistor off condition
- In RF application condition
- Heavy ion test has revealed (at low LET)
  - SEE in a GaAs MESFET transistor
    - Transients recorded for both cases
    - Destructive events for both cases
      - At same LET with lower RF levels SEE immunity has been demonstrated
  - Monitoring data shows no cumulative effects
  - SEE cross section is around 10e-3 cm2 ~total gate area
  - Results from all tested samples (in total 7 with heavy ions and 2 with Cf-252) are consistent



## ESA Alert EA-2008-EEE-05A

- Historically heavy ion effects in GaAs MESFET and HFET has not been considered critical (at least at ESA)
  - All reviewed GaAs PADs in ESA programs states SEE insensitivity
  - GaAs MESFET in Power Amplifier application considered most critical
- Recommendations in the Alert
  - the voltage in the RF swing must respect the Heavy Ion SOA
    - ⇒In Heavy ion test with DC bias it is not always possible to apply DC up to the level of the RF swing

⇒Only option left is heavy ion test with RF

- or justification with flight heritage...

## **ESA ongoing activities**

- A internal Task force team has been established that continuously support the programs with respect to the ESA Alert
  - Support heavy ion test on case by case basic
- One person has been dedicated for the purpose to with experiments
  - Map the extent of the problem with radiation tests on GaAs MESFETS and HFET devices from several different manufacturers.
  - Gain deeper understanding of the SEE mechanism in GaAs MESFET
  - Evaluate different test approaches/methods for GaAs MESFET and other RF amplifier device types/technologies.

## Latest Updates Heavy ion testing on GaAs MESFET devices

Tested GaAs FETs	LET(GaAs) MeV- cm2/mg	Transients <20ns	Destructive events in RF condition
In-Flight failure GaAs MESFET	<5	Low voltage levels	Yes
Mitsubishi MESFET	62	Near BVds	No
Triquint HFET	62	Near BVds	No
Triquint PHEMT	49	Near BVds	No

